

MYC60 BASE 1-part pumps

2-part pumps

MYC60 PRO

1-part pumps 2-part pumps (V)

2-part pumps(A)

2-part pumps (V)

Bringing tomorrow's electronics to life







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Automated industrial dispensing for a rugged world

MYSmart[™] series MYC60[™]



Give your industrial assemblies the protection they deserve

It's a rough world out there for industrial electronics. Leading tier-one EMS facilities worldwide rely on Axxon Mycronic's MYC60 Industrial Dispenser for their toughest structural, thermal, sealing, bonding and gasketing needs.



As an industry leader in precision jetting, dispensing and coating solutions, Axxon Mycronic has long been at the forefront of industrial automation in electronics protection. The MYC60 takes these capabilities to a new level, giving manufacturers a versatile, customizable platform for high-volume dispensing of nearly any 1K or 2K material.

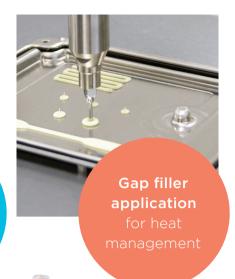
Whether you're producing automotive assemblies, 5G infrastructure or aerospace electronics, the MYC60 offers an all-in-one solution to all your demands for 24/7 dispensing, pumping, metering and process control. From medium to high-volume production. In-line or batch configurations. Complete with a wide array of conveyor, trolley and robotic integration options. Whatever your application, the MYC60 offers the latest process controls together with the quality and flexibility Mycronic is known for.

BRING ON YOUR TOUGHEST CHALLENGES

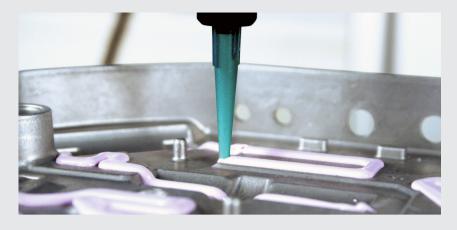
From thermal interface dispensing and bonding of THT components, to casting, potting, gasketing and sealing, the MYC60 can be custom-designed to meet your toughest industrial dispensing needs. Contact Axxon Mycronic today to discuss your requirements.













Thermal interface materials (TIM)

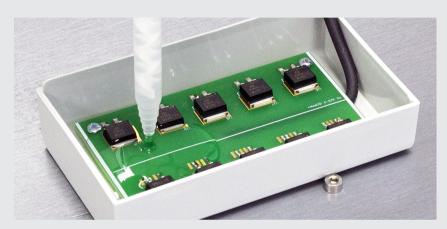
Take the heat off your assemblies with superior levels of vertical and horizontal control. The MYC60's advanced dispense and mixing technologies make it possible to apply nearly any thermal conductive material into nearly any gap with unmatched speed and precision.



Casting and potting

Seal your electronics from heat, moisture and vibration, or protect them from prying eyes.

From batteries to sensors to proprietary products, there's no limit to what you can cast and encapsulate.







Bonding

Are your THT components vulnerable to shocks and vibrations? Now you can bond even the most complex geometries with a wide range of 1K and 2K materials.



Sealing and gasketing

Seal virtually any shape with better consistency and less effort. Whatever your pattern or line width, the MYC60 is there to fill the gaps.

